

General Description

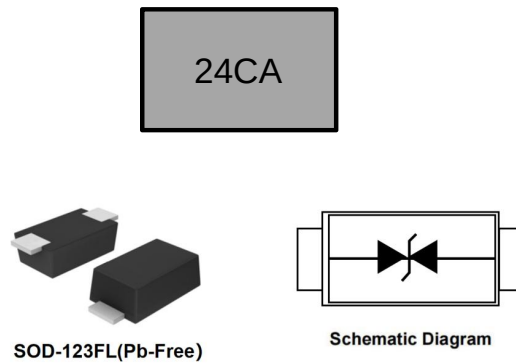
The **GS24VHS1DFBL** is designed to protect voltage sensitive components from damage or latch-up due to surge current. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to surge current protection for board level. Because of its small size and bi-directional design, it is ideal for use in cellular phones and portable applications that require audio line protection.

Features

Low incremental surge resistance
Low Clamping Voltage: $V_C=32V@I_{PP}=185A$
Reverse Working (Stand-off) Voltage: 24.0 V
Low Leakage
Response Time is Typically < 1 ns
IEC61000-4-2 Level 4 ESD Protection

Applications

Mobile Internet Devices (MID) and portable devices
Personal digital assistants (PDA's)
Cellular handsets and accessories



Absolute Maximum Rating

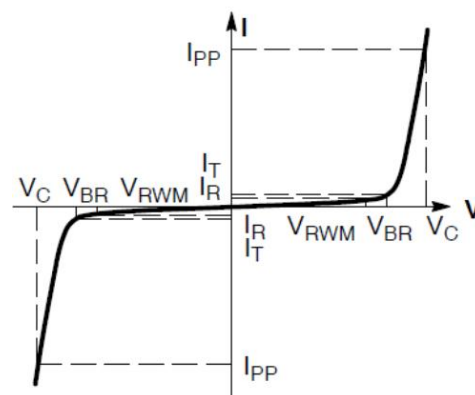
Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Contact		±30	kV
Peak Power Per 8 x 20μs Waveform	P_{PK}	5900	W
Junction Temperature Range	T_J	-55 to +125	°C
Storage Temperature Range	T_{stg}	-55 to +150	
Lead Solder Temperature – Maximum (10 Second Duration)	T_L	260	°C

Electrical Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Stand-off Voltage	V_{RWM}				24.0	V
Reverse Breakdown Voltage	V_{BR}	$I_T=1mA$	25.5			V
Reverse Leakage Current	I_R	$V_{RWM}=24.0V$			1.0	μA
Clamping Voltage	V_C	$I_{PP}=90A$ $t_p=8/20\mu s$			28	V
		$I_{PP}=185A$ $t_p=8/20\mu s$			36	
Junction Capacitance	C_J	$V_R=0V$, $f = 1MHz$		300	400	pF

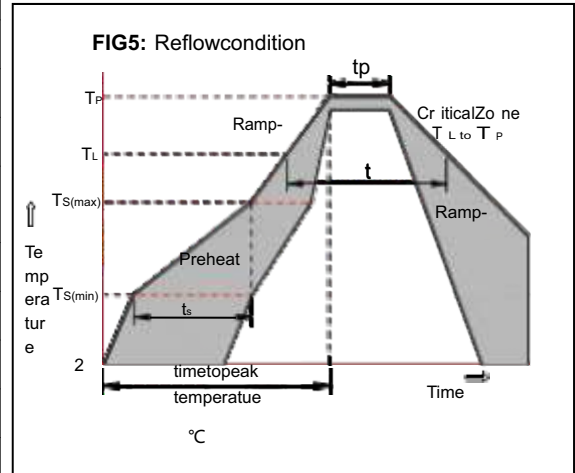
Electrical Parameters (TA = 25°C unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
I_T	Test Current
V_{BR}	Breakdown Voltage @ I_T
P_{PK}	Peak Power Dissipation
C	Max. Capacitance @ $V_R = 0$ and freq.=1 MHz



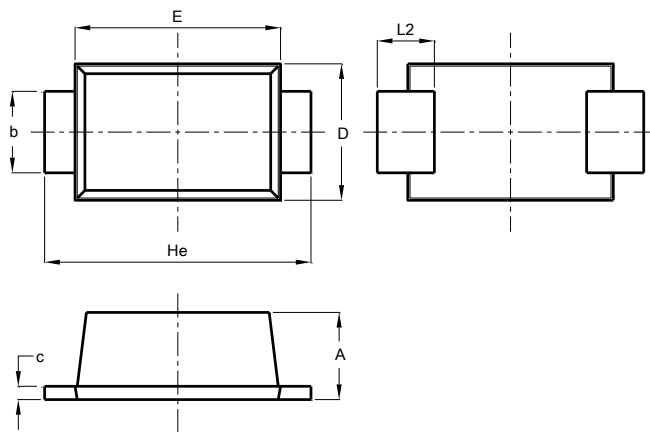
Soldering parameters

ReflowCondition		Pb-Freeassembly (seeasbellow)
Pre Heat	-TemperatureMin($T_{s(min)}$)	+150°C
	-TemperatureMax($T_{s(max)}$)	+200°C
	-Time(MintoMax) (t_s)	60-180 secs.
Average rampup rate(LiquidusTemp (T_L)topeak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-upRate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
PeakTemp(T_p)		+260(+0/-5)°C
Timewithin5°CofactualPeakTemp(t_p)		30secs. Max
Ramp-down Rate		6°C/sec. Max
Time25°C to PeakTemp(T_p)		8min.Max
Donotexceed		+260°C

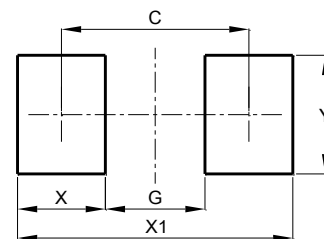


Package Dimensions & Suggested Pad Layout

SOD123FL

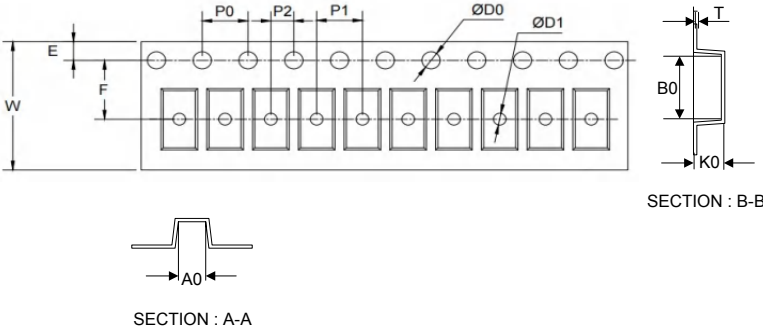
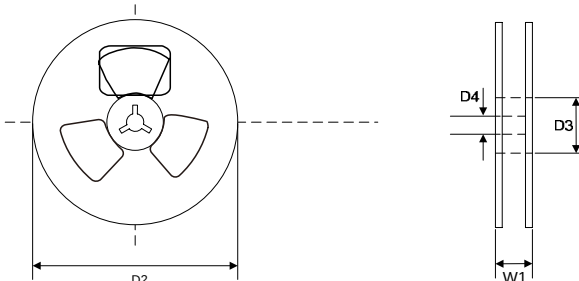


SOD123FL		
Dim	Min	Max
A	1.00	1.20
b	0.80	1.10
c	0.12	0.20
D	1.75	1.95
E	2.60	2.90
He	3.55	3.80
L2	0.50	0.85
All Dimensions in mm		



Dimensions	Value (in mm)
C	3.25
G	2.00
X	1.25
X1	4.50
Y	1.50

Tape & reel specification

Tape		Symbol	Dimension (mm)
		P0	4.00±0.20
		P1	4.00±0.20
		P2	2.00±0.20
		D0	1.55±0.15
		D1	1.00±0.20
		E	1.75±0.20
		F	3.50±0.25
		W	8.00±0.20
		A0	1.85±0.20
		B0	3.95±0.20
		K0	1.30±0.20
		T	0.21±0.10
		D2	178.0±5.0
		D3	55.0Min.
		D4	10.0±2.5
7" Reel		W1	11.5±2.5
		Quantity: 3000PCS	